

Harvatek Surface Mount CHIP LEDs Data Sheet B3DB3BRG-05C000113U1930

Features

- Support signal reshaping to pass control waveforms to next adjacent driver
- Cascading port transmission by a single data line
- Built-in current regulator, three-way drive.
- Optional- Optional maximal drive current: 5mA
- 256-step gray-scale output to allow 16,777,216 color display
- 32-step dimming control
- Built-in oscillator 20MHz
- LED driver port maximum withstand Voltage 6.5V
- Built-in power-on-reset (2.6V) (@VDD=5V)
- Operating voltage 3.3~5.5V
- Support sleep and wake up mode for power-saving

Applications

- Decorative LED lighting
- LED video display



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Tentative Product	*****	*****	*****
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DISCLAIMER

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HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

Item	Specification	Material	Quantity
Luminous Intensity(Iv)	Red : 100~360 mcd Green : 110~400 mcd Blue : 40~110 mcd IC@5V, R/G/B@5mA Ts= 25 ^o C; Tolerance ±10%		
Wavelength	Red : 618~625 nm Green : 520~535 nm Blue : 460~474 nm IC@5V, R/G/B@5mA Ts= 25 ^o C; Tolerance ±10%		
Applied voltage	5V_DC		
View angle	120 ^o		
Resin	Clear	Epoxy	
Carrier tape		Conductive black tape	3000 ea/reel
Reel		Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λD and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note :This is shipped test conditions

※Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection

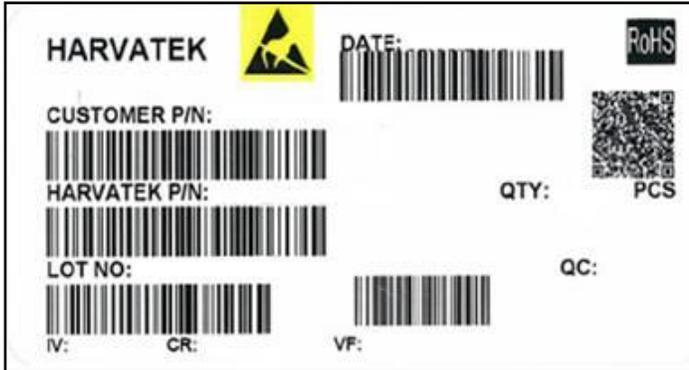


The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlGaInP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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Label Specifications



Harvatek P/N:

B 3DB 3 BRG- 05C- 0001 13

Product	Package	Dice Qty	Color	Current	Series Number	Taping
PCB	1.6(L)x1.6(W)x0.9(H) mm	3:Tri	BRG(Full Color)	5mA	X001~XZZZ	1. Taping style 2. Qty

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2020-L		1:A	01~ZZ		000~ZZZ		
		2021-M		2:B					
		2022-P	1:Jan.	3:C					
		2023-Q	2:Feb.	...					
		26:Z					
		2026-T	A:Oct.	27:7					
		2027-V	B:Nov.	28:8					
		...	C:Dec.	29:9					
		2030-Y		30:3					
		2031-Z		31:4					
...									

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Specifications Range

■ Luminous Intensity (Iv) :

Color	Spec. Range
R	100-360 mcd
G	110-400 mcd
B	40-110 mcd

Note: It maintains a tolerance of $\pm 10\%$ on luminous intensity

■ Wavelength :

Color	Spec. Range
R	618-625 nm
G	520-535 nm
B	460-474 nm

Note: It maintains a tolerance of $\pm 0.5\text{nm}$ on Wavelength Bin

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Product Features

Electro-Optical Characteristics

(T_{Soldering}, 25 °C)

Series	Emitting Color	Material	Wavelength λ(nm)			I _v (mcd)	Viewing
			λ _D	λ _P	Δλ	Typical	Angle $2\theta \frac{1}{2}$
B3DB3BRG	R	AlGaInP	620	630	18	80	120
	G	InGaN	525	518	35	120	120
	B	InGaN	466	465	25	35	120

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

(Unit:mm Tolerance: +/-0.1)

Outline Dim.	Suggest Soldering Pattern
Soldering terminals may shift in the x, y direction.	

Absolute Maximum Ratings (unless otherwise specified, Temperature=25°C)

(T_{Soldering} 25 °C)

Characteristic	Symbol	Rating	Unit
Supply Voltage	VDD	6.5	V
Power Dissipation	PD	<400	mW
Maximum Output Current	I _{LEDOUT}	25	mA
Welding Temperature	TM	300(8S)	°C
Operating Temperature Range	TOPR	-40~85	°C
Storage Temperature Range	TSTO	-65~125	°C

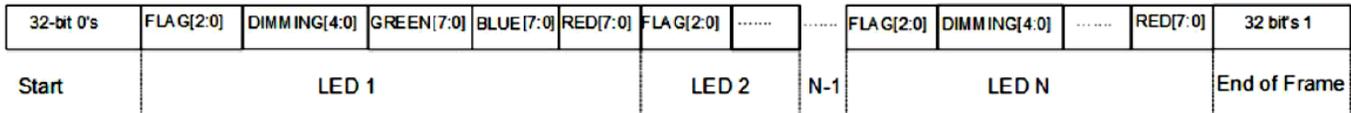
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Electrical Characteristics

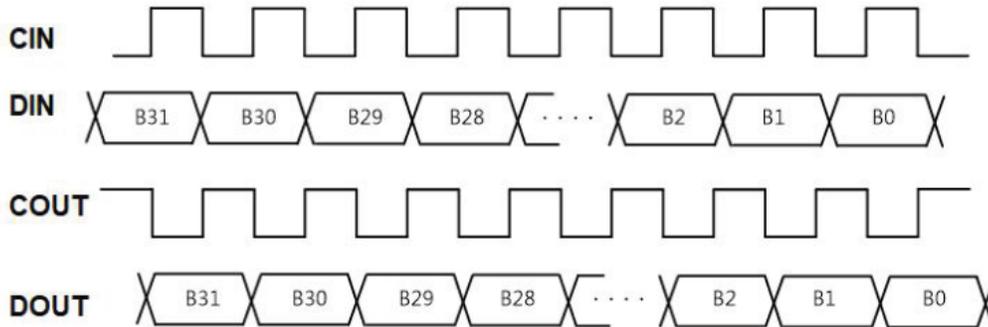
Characteristic	Symbol	Condition	Limit			Units
			Min.	Typ.	Max.	
Supply Voltage	VDD	-	3.3	5.0	5.5	V
Operation Current	I _{dyn}	VDD=5V、RGB off			1.5	mA
Standby Current	I _{sleep}	-		1		uA
Logic input control DIN/CIN						
Input High "H"	V _{IH}	-	2.7	-	VDD+0.4	V
Input High "L"	V _{IL}	-	-0.4	-	1.0	V
DIN Pull-up resistance @normal mode	R _{IN}			80K		Ω
CIN Frequency	C _{FREQ}				15	MHz
CIN High pulse width	T _{CKH}		30			ns
CIN Low pulse width	T _{CKL}		30			ns
DIN to CIN setup	T _{SETUP}		10			ns
DIN to CIN hold time	T _{HOLD}		5			ns
Logic output DOUT/COUT						
Output High "H"	V _{OH}	4mA @VDD=5V	4.5	-	-	V
Output Low "L"	V _{OL}	4mA @VDD=5V	-	-	0.4	V
Sink Current R/G/B						
R, G, B Sink Current	I _{SINK}	@VDD-V _{fLED} ≥ 1.5V	4.75	5	5.25	mA

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Data Transfer Protocol



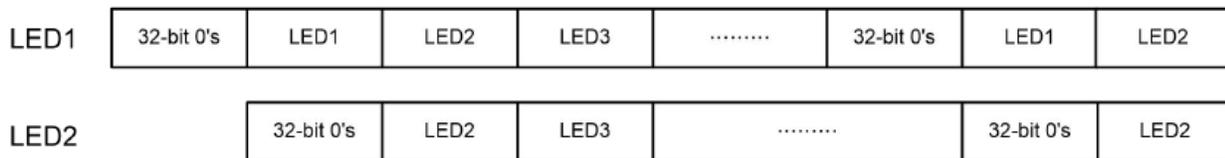
32 consecutive 0's denote the start of a command for an RGB LED. After receiving 32 0's, the IC gets the following 32 bits as the received command, including FLAG, DIMMING, GREEN, BLUE and RED fields.



The serial command is transmitted with MSB first, DIN is latched at the rising edge of CIN clock. COUT and DOUT are re-generated for the next RGB LED. COUT is inverted from CIN. When 32 consecutive 0's are encountered, the next 1 is expected to start a 32-bit command, i.e., FLAG[2:0]=111. When FLAG[2:0]=111, then DIMMING, GREEN, BLUE and RED fields are latched respectively.

while the current 32-bit command is got, the IC passes remaining command bits to the next RGB LED.

After the last one command is issued for the last LED (LED n), the following 32 consecutive 1's denote the end of the current command for an RGB LED(End of Frame) and wait for next 32 consecutive 0's to start a new command set.(Note: the IC is workable either with or without "End of Frame" command, **but MCU should issue the extra N/2 numbers of clocks signal if there are N LED lamps totally connected in the strip to make sure the data transfer and display of the last one LED lamp is complete and correct**).



FLAG[2:0] : 111 to start a 32-bit command

DIMMING[4:0] : 32-level current control for R/G/B drivers

GREEN [7:0] : 256 gray levels for blue LED

BLUE [7:0] : 256 gray levels for green LED

RED[7:0] : 256 gray levels for red LED

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Sleep and power saving mode

The IC supports the sleep/wake-up modes for power-saving purpose. In sleep mode, the built-in oscillator and associated circuitry will be disabled. The quiescent current of the IC is approximately 1uA(typ.).

Command Setup to enable sleep or wake up mode

When receiving 24-bit 0's GBR data (that is GREEN [7:0]=8h00, BLUE [7:0]=8h00, RED[7:0]=8h00), in the meantime, both of the data in 3-bits' flag and 5-bits' DIMMING is 8h'A0' (that is FLAG[2:0]=3b101 and DIMMING[4:0]=5b00000), the IC will enter sleep mode.

The IC will wake up from sleep mode once receiving the new data with the data of Flag[2:0] · DIMMING[4:0] is not 8h"A0"; after wake-up, all sleeping circuits in the IC return to normal working mode within 1ms. Since it takes 1ms for a sleeping the IC returning to normal function mode, it is recommended for a host to wait for 1ms to send display data and command after issuing a wake-up command.

Sleep power-saving mode example:

32 bits 0	Flag[2:0]=3'b101	Dimming[4]=5'b00000	Green [8'h00]	Blue [8'h00]	Red[8'h00]	Sleep mode
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Case 1:

Lamp 1	Lamp 2	Lamp 3
1xx111118hFF8hFF8hFF	101000008h008h008h00	101000008h008h008h00
Normal mode	Sleep mode	Sleep mode

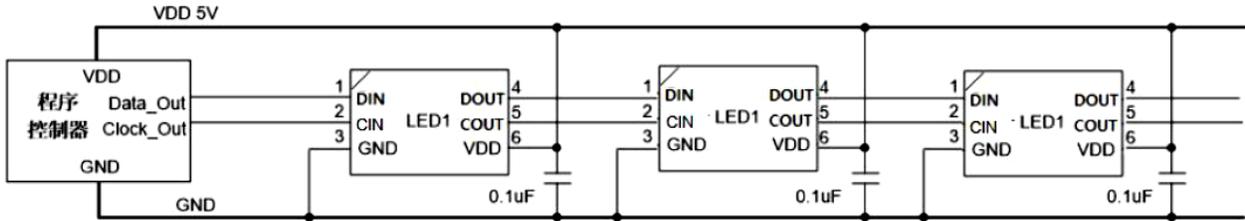
Case 2:

Lamp 1	Lamp 2	Lamp 3
1xx111118hFF8hFF8hFF	101000008h008h008h00	1xx111118h1F8h1F8h1F
Normal mode	Sleep mode	Normal mode

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In case 2, while lamp2 is under sleep mode, in the following data transfer process, the state of lamp 2 will be not changed as long as the 32 bits data for lamp 2 is received with data of Flag[2:0] · DIMMING[4:0] being 8h"A0". It means lamp2 will keep in sleep mode as well. In the situation, lamp2 can pass through the remaining data to lamp 3 (32bits) to change the display data of lamp 3. In other words, the sleeping chip is able to pass the data to the next chips.

Typical Circuit of an RGB LED strip application



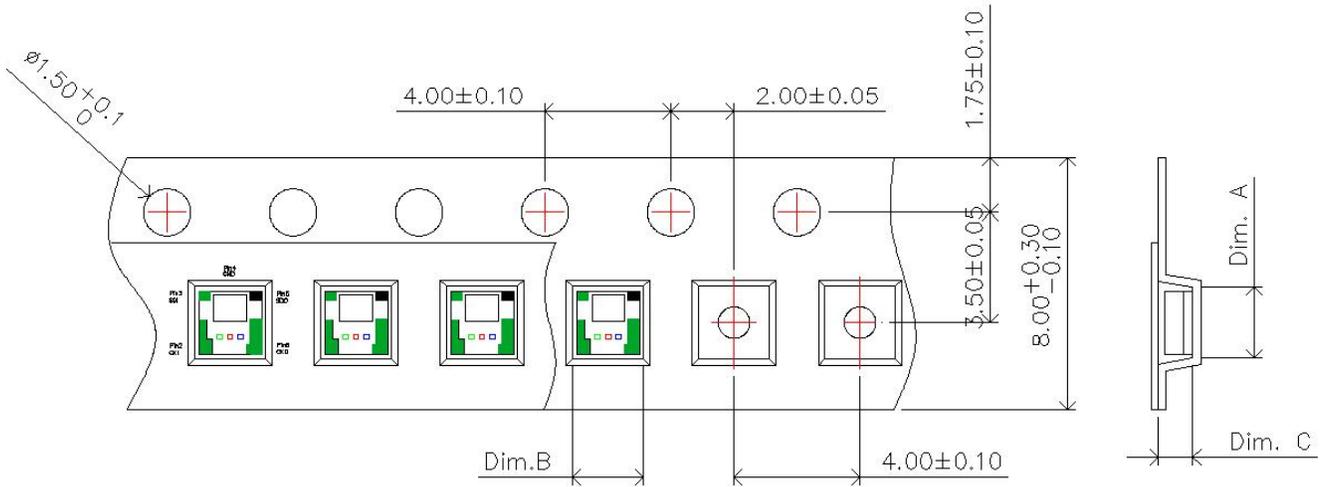
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Precaution for Use

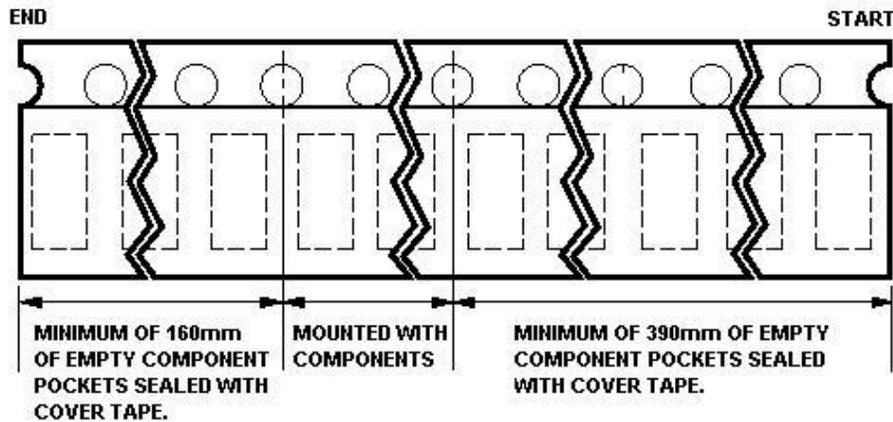
1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 72 hours after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

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Packaging Tape Dimension

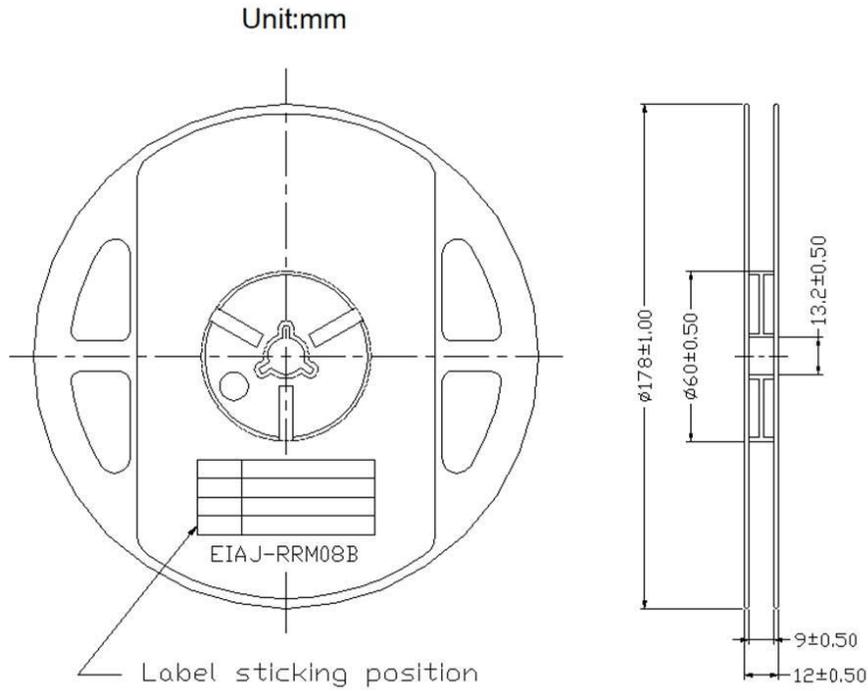


Dim. A	Dim. B	Dim. C	Qty/Reel
1.73±0.05	1.73±0.05	1.10±0.05	3K

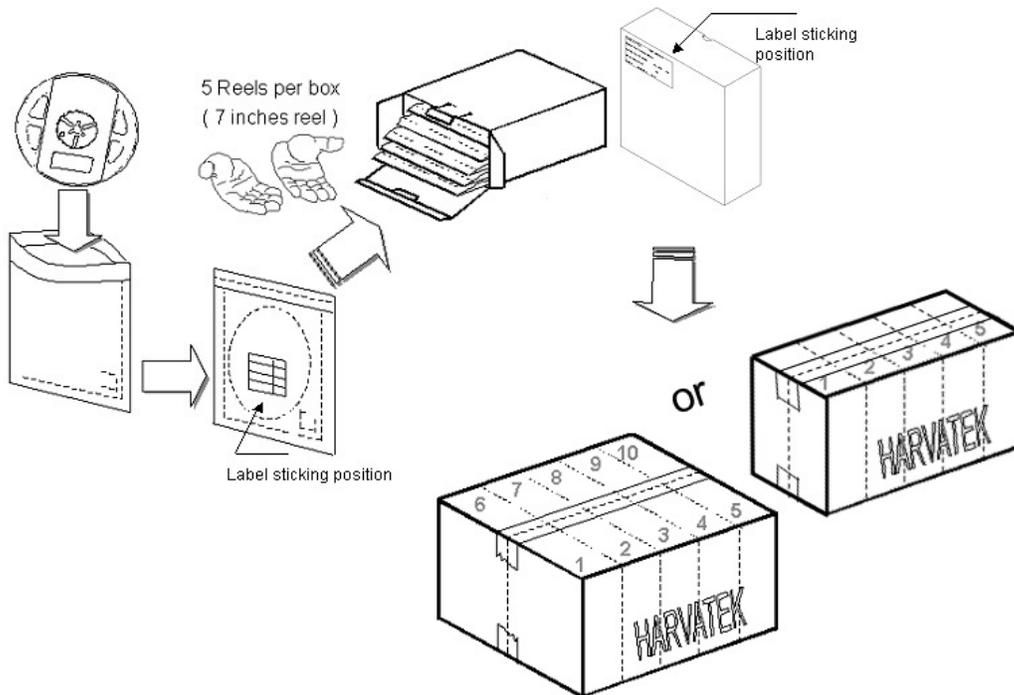


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Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

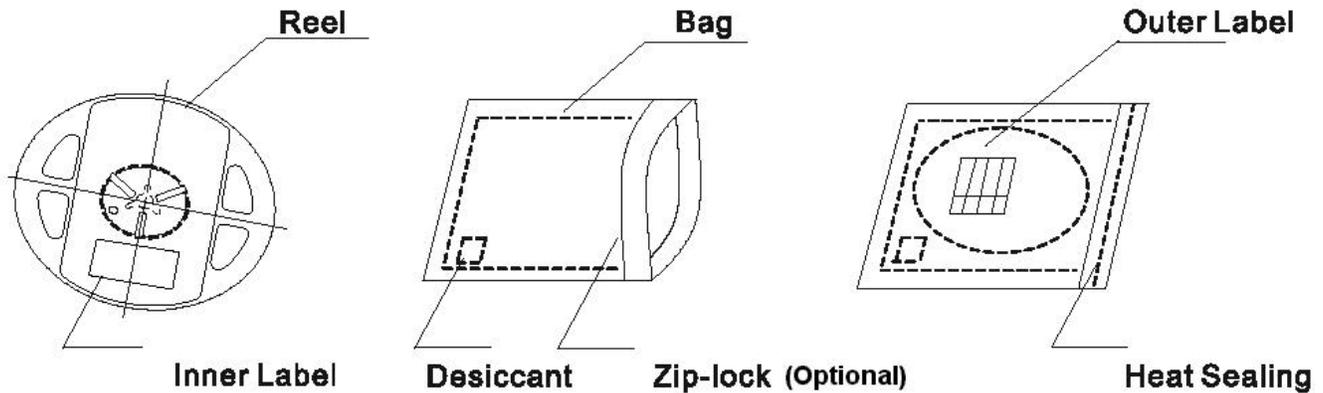
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 72 hours.

The conditions are as followings:

1. $60\pm 3^{\circ}\text{C} \times (12\sim 24\text{hrs})$ and $<5\%RH$, taped reel type.
2. $100\pm 3^{\circ}\text{C} \times (45\text{min}\sim 1\text{hr})$, bulk type.
3. $130\pm 3^{\circ}\text{C} \times (15\text{min}\sim 30\text{min})$, bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

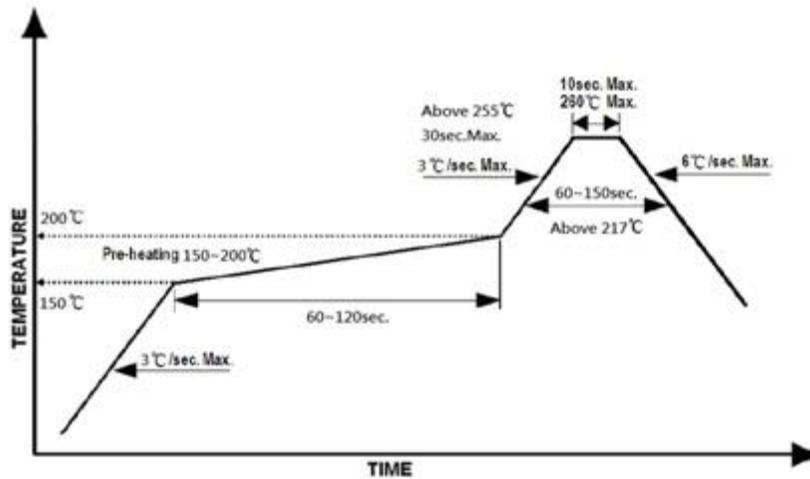
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec.
2. Peak temp.:260 °C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C .
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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